

# MICHAEL BELLA

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88 E. San Fernando St Unit 711, San Jose, CA 95113

## TECHNICAL STRENGTHS

<b>Programming Languages</b>	Embedded C, LabView, Python, C/C++
<b>Software Tools</b>	Eclipse, Git, SVN, Code Composer Studio, IAR, Spice AWR Microwave Office, CADSoft Eagle, Matlab
<b>Design Experience</b>	Low Power Embedded Systems, RF Matching Networks & Amplifiers Analog Signal Processing, High Precision Analog Measurement, SMPS Design
<b>Lab Skills</b>	Root Cause Analysis, SMD Soldering, Wiring harness construction, PCA Bringup and Debugging, Prototyping, Build designs from print
<b>Other Technical Experience</b>	Proficient with Linux, Texas Instruments MSP430 Processor Family

## WORK EXPERIENCE

<b>KLA-Tencor</b> <i>Electrical Engineer</i>	December 2011 - Present <i>Milpitas, CA</i>
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- Debug and perform root cause analysis on systems including manufacturing fixtures, embedded data acquisition systems, and RF systems.
- Write LabView software to acquire and process data from a wide range of lab equipment
  - Network Analyzers, Impedance Analyzers
  - Ocean Optics Spectrometers
  - Digital Multimeters and Oscilloscopes
- Write embedded C for the low power MSP430 processor family
  - Design embedded systems to serve as platforms for new sensor technologies.
  - Adapt existing measurement system architectures for use with new sensor types.
  - Modify existing embedded system code bases to work with new types of sensors.
- Write Python software to process data from new types of sensors being researched in R&D.
  - Apply calibration factors and remove intrinsic sensor offset from the data.
  - Automatically identify process steps in the data, separate them into different data sets, and perform statistical analysis on them.
- Design RF matching networks for use in 13.56MHz systems.
- Design build and program test fixtures and experimental fixtures driven by LabView.
  - Measure on state resistance of DIO pins on an MSP430 microcontroller for use in an error budget workup.
  - Test and calibrate CPU flex circuits at different stages in the build process.
  - Test the functionality of sensor ICs at different steps in their processing.
  - Accurately measure instantaneous power usage of low power embedded systems for use in power budget creation and optimization.

<b>KLA-Tencor Internship</b> <i>Electrical Engineer</i>	June 2005 - December 2011 <i>Milpitas, CA</i>
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- Performed PCB/PCA diagnostic work and repair, failure analysis, SMD rework.
- Developed LabView code to interface with test equipment, and custom embedded systems.
- Characterized the magnetically coupled wafer communication system

## EDUCATION

<b>San Jose State University</b> B.S. in Electrical Engineering	<i>December 2011</i>
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